



## Material Content Data Sheet



<b>Sales Product Name</b>				XMC1301-Q040F0016 AB		<b>Issued</b>		24. January 2018	
<b>MA#</b>				MA001687322					
<b>Package</b>				PG-VQFN-40-13		<b>Weight*</b>		69.21 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	1.634	2.36	2.36	23613	23613	
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		135		
	non noble metal	zinc	7440-66-6	0.037	0.05		540		
	non noble metal	iron	7439-89-6	0.748	1.08		10807		
wire	non noble metal	copper	7440-50-8	30.371	43.88	45.02	438826	450308	
	noble metal	palladium	7440-05-3	0.003	0.00		40		
	non noble metal	copper	7440-50-8	0.274	0.40	0.40	3959	3999	
encapsulation	organic material	carbon black	1333-86-4	0.103	0.15		1490		
	plastics	epoxy resin	-	5.395	7.80		77954		
	inorganic material	silicondioxide	60676-86-0	28.866	41.71	49.66	417078	496522	
leadfinish	noble metal	palladium	7440-05-3	0.000	0.00		5		
	noble metal	silver	7440-22-4	0.000	0.00		4		
	noble metal	gold	7440-57-5	0.001	0.00		8		
	non noble metal	nickel	7440-02-0	0.544	0.79	0.79	7867	7884	
plating	noble metal	silver	7440-22-4	0.000	0.00		5		
	noble metal	gold	7440-57-5	0.001	0.00		9		
	noble metal	palladium	7440-05-3	0.000	0.00		5		
	non noble metal	nickel	7440-02-0	0.609	0.88	0.88	8804	8823	
glue	plastics	bismaleimide resin	-	0.123	0.18		1770		
	noble metal	silver	7440-22-4	0.490	0.71	0.89	7081	8851	
*deviation	< 10%					Sum in total:	100.00	1000000	

### Important Remarks:

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